Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IDC Wab Site for Information on IDC 1752 Standard Form Type				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materi	ials and Mfg Information				
Supplier	r Information														
Company name* Company unique ID					Unique ID Authority					Response Date*					
On Semico	onductor											2021-02-03			
Contact Name Title - Conta				tact			Phone - Contact*					Email - Contact*			
Product-I	Env-Stewards		Product Envi	iro Compliance			NA					Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Re				Representative			Phone - Representative*				Email - Representative*				
Product-I	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Dat	ve Date Version Manufacturing Site		W	eight*	UOM	Unit Type		
		1N5934BG ZEN SUR30 RI		ZEN SUR30 REG 3	3W 24V		2021-02-03 CN3			30	51.01	mg	Each		
Manufa	cturing Proccess Informa	ition						•		,					·
	Terminal Plating / Grid Array Material To			erminal Base Alloy J-STD-020 M		L Rating	Peak Process Body Temperature Max		ture Max T	ime at Peak	Temperatu	re Numb	er of Reflow Cyo	eles	
		CU Alloy NA		A		0		C	30		second	s 3			
omments	3														
			<u> </u>			<u> </u>	<u> </u>								
or more	information regarding material	composition	nlesse refer t <i>e</i>	nage 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.67	mg	Supplier	Silicon (Si)	7440-21-3		2.67	mg
Die Attach Solder	12.67	mg	Supplier	Silver (Ag)	7440-22-4		0.3168	mg
			A	Lead (Pb)	7439-92-1	7a	11.7198	mg
			Supplier	Tin (Sn)	7440-31-5		0.6335	mg
Lead Frame	198.45	mg	В	Nickel (Ni)	7440-02-0		2.183	mg
			Supplier	Copper (Cu)	7440-50-8		196.267	mg
Mold Compound-Black	139.28			Metal Hydroxide	proprietary data		6.964	mg
			Supplier	Carbon Black (C)	1333-86-4		1.3928	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		104.46	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		13.928	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		12.5352	mg
Plating	7.94	mg	Supplier	Tin (Sn)	7440-31-5		7.94	mg